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October 2024

FDB0105N407L

N-Channel PowerTrench[®] MOSFET 40 V, 460 A, 0.8 m Ω

Features

- Max $r_{DS(on)}$ = 0.8 m Ω at V_{GS} = 10 V, I_D = 50 A
- Max $r_{DS(on)}$ = 1.1 m Ω at V_{GS} = 6 V, I_D = 42 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low R_{DS(on)}
- High Power and Current Handling Capability
- RoHS Compliant

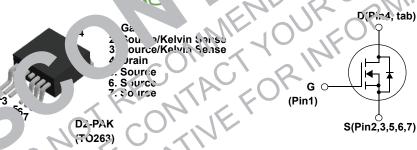
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench® process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications

Applications

- Industrial Motor Drive
- Industrial Power Sonly
- Industrial A: mation.
- Battery pera 1 tools
- E ~v Pr `ctio.
- So, Inv.
- PS ₁ 1 Energy Invectors
- Ei rgy Storage
- Load Svitch





Natings To = 25 °C In ess otherwise noted.

| m, 1 | Paramete | r | | Ratings | Units |
|-----------------------------------|---|------------------------|-----------|-------------|-------|
| V _{DS} | Drain to Source Voltage | | | 40 | V |
| V _{GS} | Gate to Source Voltage | | | ±20 | V |
| | Drain Current -Continuous | T _C = 25°C | (Note 5) | 460 | |
| 5 | -Continuous | T _C = 100°C | (Note 5) | 330 | Α |
| | -Pulsed | | (Note 4) | 2540 | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 1109 | mJ |
| D | Power Dissipation | T _C = 25°C | | 300 | W |
| P_{D} | Power Dissipation | T _A = 25°C | (Note 1a) | 3.8 | VV |
| T _J , T _{STG} | Operating and Storage Junction Temperatur | re Range | | -55 to +175 | °C |

Thermal Characteristics

| R | ÐJC | Thermal Resistance, Junction to Case | (Note 1) | 0.5 | °C/W |
|---|-----|---|-----------|-----|------|
| R | 9JA | Thermal Resistance, Junction to Ambient | (Note 1a) | 40 | C/VV |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|--------------|-----------|-----------|------------|-----------|
| FDB0105N407L | FDB0105N407L | D2-PAK-7L | 330mm | 24mm | 800 units |

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Electrical Characteristics T_J = 25 °C unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|--|--|--|------|------|------|-------|
| Off Chara | acteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 40 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ | Breakdown Voltage Temperature Coefficient | I _D = 250 μA, referenced to 25 °C | | 13 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 32 V, V _{GS} = 0 V | | | 1 | μА |
| I _{GSS} | Gate to Source Leakage Current | V _{GS} = ±20 V, V _{DS} = 0 V | | | ±100 | nA |

On Characteristics

| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250 \mu A$ | 2 | 2.8 | 4 | V |
|--|--|---|---|-----|------------|-------|
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | I_D = 250 μ A, referenced to 25 °C | , | | | mV/°C |
| r _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$ $V_{GS} = 6 \text{ V}, I_D = 42 \text{ A}$ | | 6 |).8 1.1 | rnΩ |
| | | $V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}, T_J = 15 \text{ C}$ | | 1 | 1.8 | |
| 9 _{FS} | Forward Transconductance | V _{DS} = 10 V, I _D = 50 A | | 286 | N | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V = 00 (V) | pF |
|------------------|------------------------------|-------------|----|
| C _{oss} | Output Capacitance | | pF |
| C _{rss} | Reverse Transfer Capacitance | 7/3 1/65 | pF |
| R_g | Gate Resistance | 2.6 | Ω |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | 45 | 73 | ns |
|---------------------|--|-----|-----|----|
| t _r | Rise Time $V_{DD} = 20 \text{ V} \text{ I}_D = 50 \text{ A},$ | 69 | 110 | ns |
| t _{d(off)} | Turn-Off Delay Time $V_{CS} = 10 \text{ V}, R_{GEN} = 9 \Omega$ | 117 | 186 | ns |
| t _f | Fall Time | 61 | 97 | ns |
| Q_g | Total Gate Correge | 208 | 291 | nC |
| Q_{gs} | G: Sourc Sate / arge V _{DD} = 20 V, I _D = 50 A, V _{GS} = 10 V | 64 | | nC |
| Q_{gd} | G "Miller Charge | 29 | | nC |

a Γ Characteristics

| | M. 'mum Continuous Drainte Source Diode Forward Current | - | - | 460 | Α |
|-----------------|--|---|-----|------|----|
| I _{Sh} | Maximu n Pulsed Drain to Source Dicate Forward Current | | | 2540 | Α |
| V _{SD} | Source to Drain Dioc'e Forward Voitage $V_{GS} = 0 \text{ V}, I_S = 50 \text{ A}$ (Note 2) | | 0.8 | 1.2 | V |
| t _{rr} | Reverse Recovery Time I _F = 50 A, di/dt = 100 A/us | | 107 | 171 | ns |
| Q _{rr} | Reverse Recovery Clarte | | 119 | 191 | nC |

R_{0,IC} is the sum of the junction (o-C asc and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,IC} is guaranteed by design will e_{N₀CA} is determined by the user's board design.

a) 40 °C/W when mounted on a 1 in 2 pad of 2 oz copper. b) 62.5 °C/W when mounted on a minimum pad of 2 oz copper.

^{2.} Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

^{3.} E_{AS} of 1109 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 86 A, V_{DD} = 10 V, V_{GS} = 36 V. 100% test at L = 0.1 mH, I_{AS} = 125 A.

^{4.} Pulsed Id please refer to Figure "Forward Bias Safe Operating Area" for more details.

^{5.} Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

Typical Characteristics $T_J = 25 \, ^{\circ}\text{C}$ unless otherwise noted.

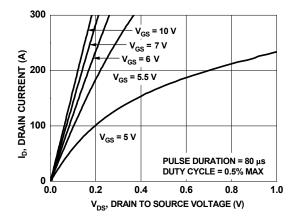
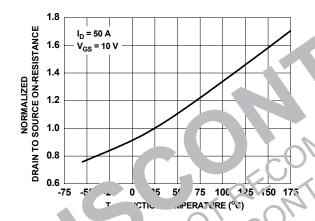


Figure 1. On Region Characteristics



ru. 3. Normalized On Resis ance
Sunction Temperature

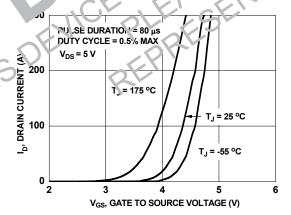


Figure 5. Transfer Characteristics

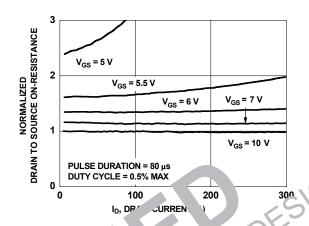


Figure 2. Normal and Conflict Resistance vs. rain Corrent and Gate Voltage

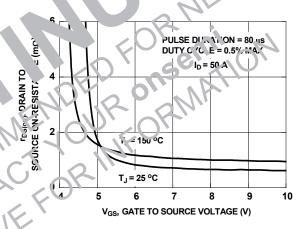


Figure 4. On-Resistance vs. Gate to Source Voltage

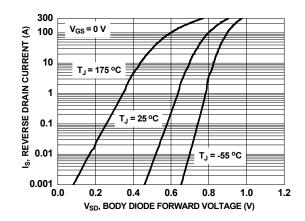
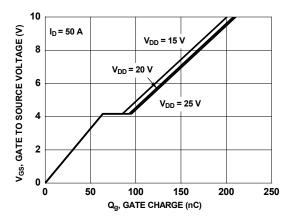


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted.



100000

(a) 10000

(b) 1000

(c) Coss

(c) Coss

(d) 10000

(d) 1000

(d) 1000

(e) 1000

(f = 1 MHz

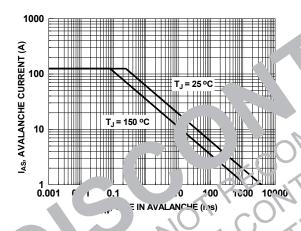
V_{GS} = 0 V

1000

(o) 1

Figure 7. Gate Charge Characteristics

Figure 8. apa ar .vs. Drainto. urc voltage



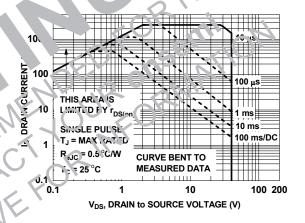


Fig. 'e9. Unclamped Inductive Switching Capability

Figure 10. Forward Bias Safe Operating Area

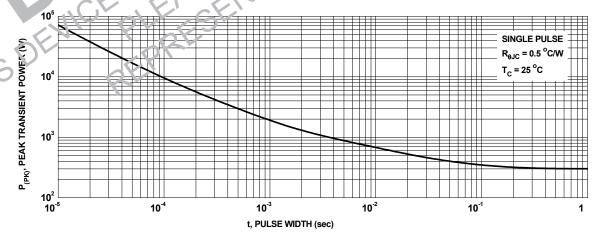


Figure 11. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

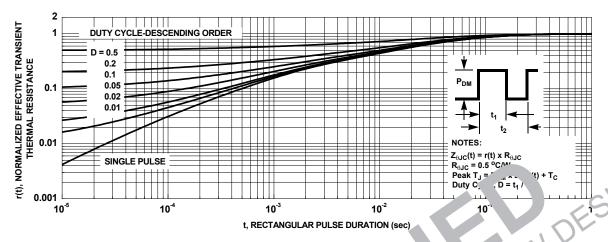
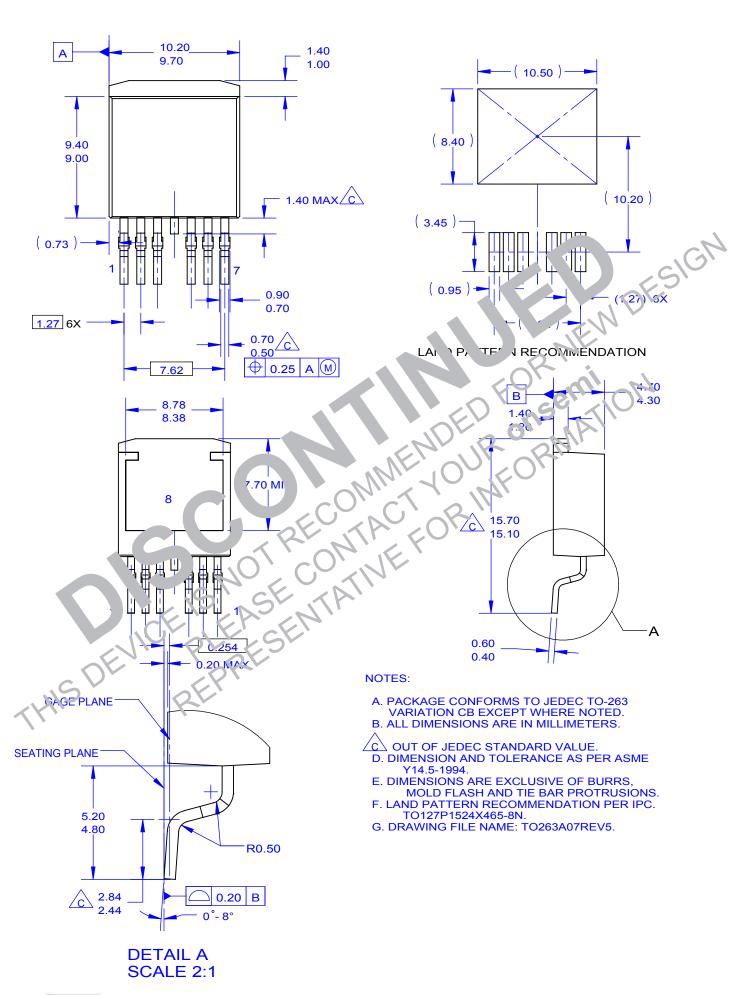


Figure 12. Junction-to-Case Transient Thermal Resp. se my





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